



Part Numbering, Leadframe Parts

SnPb Leadframe

SnPb Board Process (Low-Temp)

TLC556CDR

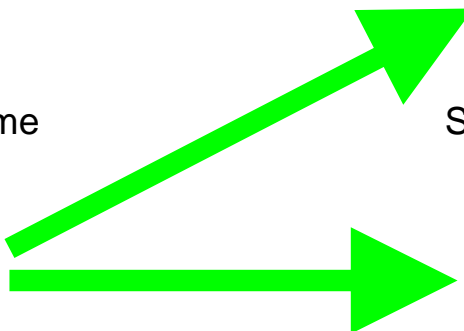


Converted

NiPdAu Leadframe

SnAgCu Board Process (High-Temp)

TLC556CDR
TLC556CDR**G4**



- TI's primary Pb-Free solution is Nickel-Palladium-Gold (NiPdAu).
- TI's Pb-Free leadframe products are backward compatible with SnPb processes.
- A Pb-Free PN will be added using JEDEC/IPC based Pb-Free codes.
- Both the Standard PN & the Pb-Free PN will be orderable part numbers.